

Low Charge Injection 24-Channel SPST High Voltage Analog Switch

Features

- ▶ 24 Channels of high voltage analog switch
- ▶ 3.3 or 5.0V CMOS input logic level
- ▶ 24 Channel SPST configuration
- ▶ 20MHz data shift clock frequency
- ▶ HVCMOS technology for high performance
- ▶ Very low quiescent power dissipation-10 μ A
- ▶ Low parasitic capacitance
- ▶ DC to 50MHz analog signal frequency
- ▶ -60dB typical OFF-isolation at 5.0MHz
- ▶ CMOS logic circuitry for low power
- ▶ Excellent noise immunity
- ▶ Cascadable serial data register with latches
- ▶ Flexible operating supply voltages

Applications

- ▶ Medical ultrasound imaging
- ▶ Piezoelectric transducer drivers
- ▶ Inkjet printer heads
- ▶ Optical MEMS modules

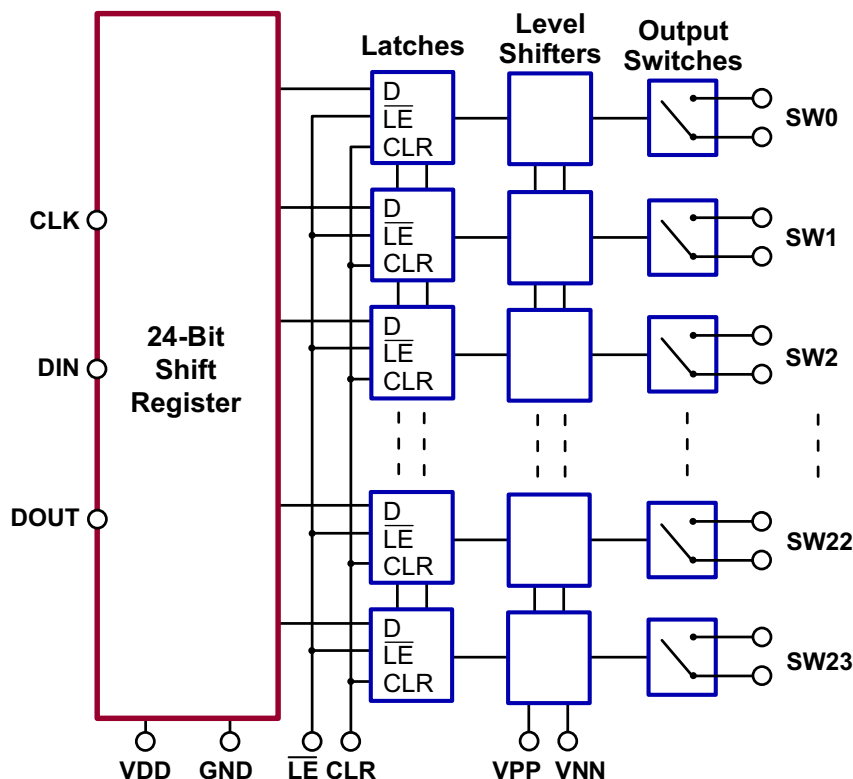
General Description

The Supertex HV2662 is a low charge injection 24-channel high voltage analog switch integrated circuit (IC) intended for use in applications requiring high voltage switching controlled by low voltage control signals, such as medical ultrasound imaging, piezoelectric transducer driver, and printers.

Input data is shifted into a 24bit shift register that can then be retained in a 24bit latch. To reduce any possible clock feed through noise, the latch enable bar should be left high until all bits are clocked in. Data are clocked in during the rising edge of the clock. Using HVCMOS technology, this device combines high voltage bilateral DMOS switches and low power CMOS logic to provide efficient control of high voltage analog signals.

The device is suitable for various combinations of high voltage supplies, e.g., V_{PP}/V_{NN} : +40V/-160V, +100V/-100V, and +160V/-40V.

Block Diagram



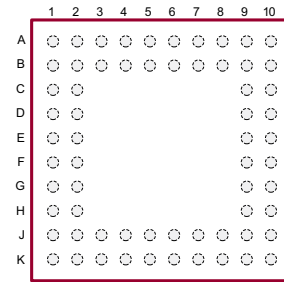
Ordering Information

Part Number	Package	Packing
HV2662LA-G	64-Pad LFGA	260/Tray
HV2662LB-G	64-Ball LFGA	260/Tray

-G indicates package is RoHS compliant ("Green")



Pin Configuration



64-Lead LFGA (LA/LB)
(top view)

Absolute Maximum Ratings

Parameter	Value
V_{DD} logic supply	-0.5V to +6.5V
$V_{PP}-V_{NN}$ differential supply	220V
V_{PP} positive supply	-0.5V to $V_{NN}+200V$
V_{NN} negative supply	+0.5V to -200V
Logic input voltage	-0.5V to $V_{DD}+0.3V$
Analog signal range	V_{NN} to V_{PP}
Peak analog signal current/channel	2.0A
Storage temperature	-65°C to 150°C
Power dissipation	1.0W

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

Product Marking

• HV2662LA
LLLLLLLLL
YYWW
AAA CCC

L = Lot Number
YY = Year Sealed
WW = Week Sealed
A = Assembler ID
C = Country of Origin
— = "Green" Packaging

Package may or may not include the following marks: Si or

64-Pad LFGA (LA)

• HV2662LB
LLLLLLLLL
YYWW
AAA CCC

L = Lot Number
YY = Year Sealed
WW = Week Sealed
A = Assembler ID
C = Country of Origin
— = "Green" Packaging

Package may or may not include the following marks: Si or

64-Ball LFGA (LB)

Typical Thermal Resistance

Package	θ_{JA}
64-Pad LFGA	36°C/W
64-Ball LFGA	37°C/W

Recommended Operating Conditions

Sym	Parameter	Value
V_{DD}	Logic power supply voltage	3.0V to 5.5V
V_{PP}	Positive high voltage supply	+40V to $V_{NN}+200V$
V_{NN}	Negative high voltage supply	-40V to -160V
V_{IH}	High level input voltage	$0.9V_{DD}$ to V_{DD}
V_{IL}	Low level input voltage	0V to $0.1V_{DD}$
V_{SIG}	Analog signal voltage peak-to-peak	$V_{NN}+10V$ to $V_{PP}-10V$
T_A	Operating free air temperature	0°C to 70°C

Notes:

- Power up/down sequence is arbitrary except GND must be powered-up first and powered-down last.
- V_{SIG} must be $V_{NN} \leq V_{SIG} \leq V_{PP}$ or floating during power up/down transition.
- Rise and fall times of power supplies V_{DD} , V_{PP} and V_{NN} should not be less than 1.0msec.

DC Electrical Characteristics (Over recommended operating conditions unless otherwise specified)

Sym	Parameter	0°C		+25°C			+70°C		Unit	Conditions	
		Min	Max	Min	Typ	Max	Min	Max			
R _{ONS}	Small signal switch ON-resistance	-	-	-	26	-	-	-	Ω	I _{SIG} = 5.0mA	V _{PP} = +40V, V _{NN} = -160V
		-	-	-	22	-	-	-		I _{SIG} = 200mA	
		-	-	-	22	-	-	-		I _{SIG} = 5.0mA	V _{PP} = +100V, V _{NN} = -100V
		-	-	-	18	-	-	-		I _{SIG} = 200mA	
		-	-	-	20	-	-	-		I _{SIG} = 5.0mA	V _{PP} = +160V, V _{NN} = -40V
		-	-	-	16	-	-	-		I _{SIG} = 200mA	
ΔR _{ONS}	Small signal switch ON-resistance matching	-	20	-	5.0	20	-	20	%	I _{SIG} = 5.0mA, V _{PP} = +100V, V _{NN} = -100V	
R _{ONL}	Large signal switch ON-resistance	-	-	-	30	-	-	-	Ω	V _{SIG} = V _{PP} -10V, I _{SIG} = 1A	
I _{SOL}	Switch OFF-leakage per switch	-	5.0	-	1.0	10	-	15	μA	V _{SIG} = V _{PP} -10V, V _{NN} +10V	
V _{OS}	DC offset switch OFF	-	300	-	100	300	-	300	mV	No load	
	DC offset switch ON	-	500	-	100	500	-	500			
I _{PPQ}	Quiescent V _{PP} supply current	-	-	-	10	50	-	-	μA	All switches OFF	
I _{NNQ}	Quiescent V _{NN} supply current	-	-	-	-10	-50	-	-			
I _{PPQ}	Quiescent V _{PP} supply current	-	-	-	10	50	-	-	μA	All switches ON, I _{SW} = 5.0mA	
I _{NNQ}	Quiescent V _{NN} supply current	-	-	-	-10	-50	-	-			
I _{SW}	Switch output peak current	-	-	-	2.0	1.3	-	-	A	V _{SIG} duty cycle < 0.1%	
f _{SW}	Output switching frequency	-	-	-	-	50	-	-	kHz	Duty cycle = 50%	
I _{PP}	Average V _{PP} supply current	-	4.0	-	-	4.5	-	5.0	mA	V _{PP} = +40V, V _{NN} = -160V	All output switches are turning ON and OFF at 50kHz with no load
		-	4.0	-	-	4.5	-	5.0		V _{PP} = +100V, V _{NN} = -100V	
		-	4.0	-	-	4.5	-	5.0		V _{PP} = +160V, V _{NN} = -40V	
I _{NN}	Average V _{NN} supply current	-	4.0	-	-	4.5	-	5.0	mA	V _{PP} = +40V, V _{NN} = -160V	All output switches are turning ON and OFF at 50kHz with no load
		-	4.0	-	-	4.5	-	5.0		V _{PP} = +100V, V _{NN} = -100V	
		-	4.0	-	-	4.5	-	5.0		V _{PP} = +160V, V _{NN} = -40V	
I _{DD}	Average V _{DD} supply current	-	8.0	-	-	8.0	-	8.0	mA	f _{CLK} = 5.0MHz, V _{DD} = 5.0V	
I _{DDQ}	Quiescent V _{DD} supply current	-	10	-	-	10	-	10	μA	All logic inputs are static	
I _{SOR}	Data out source current	0.45	-	0.45	0.70	-	0.40		mA	V _{OUT} = V _{DD} -0.7V	
I _{SINK}	Data out sink current	0.45	-	0.45	0.70	-	0.40		mA	V _{OUT} = 0.7V	
C _{IN}	Logic input capacitance	-	10	-	-	10	-	10	pF	---	

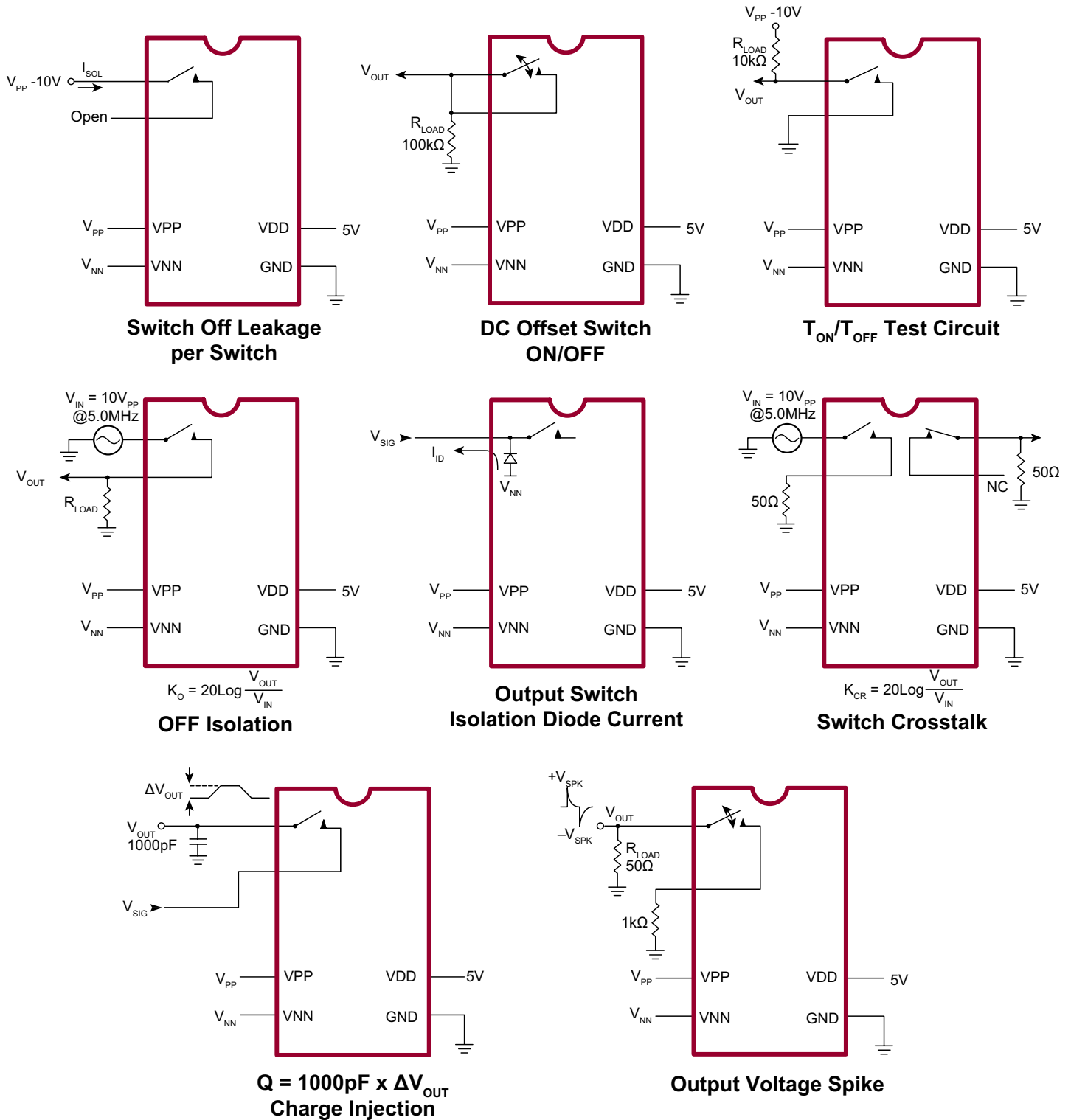
* See Test Circuits on page 5

AC Electrical Characteristics (Over recommended operating conditions unless otherwise specified)

Sym	Parameter	0°C		+25°C			+70°C		Unit	Conditions
		Min	Max	Min	Typ	Max	Min	Max		
t_{SD}	Set up time before $\overline{LE}$ rises	25	-	25	-	-	25	-	ns	---
t_{WLE}	Time width of $\overline{LE}$	56	-	56	-	-	56	-	ns	$V_{DD} = 3.0V$
		12	-	12	-	-	12	-		$V_{DD} = 5.0V$
t_{DO}	Clock delay time to data out	9.0	40	9.0	-	40	9.0	40	ns	$V_{DD} = 3.0V$
		8.0	30	8.0	-	30	8.0	30		$V_{DD} = 5.0V$
t_{WCLR}	Time width of CLR	55	-	55	-	-	55	-	ns	---
t_{SU}	Set up time data to clock	21	-	21	-	-	21	-	ns	$V_{DD} = 3.0V$
		7.0	-	7.0	-	-	7.0	-		$V_{DD} = 5.0V$
t_H	Hold time data from clock	5.0	-	5.0	-	-	5.0	-	ns	$V_{DD} = 3.0V$
		5.0	-	5.0	-	-	5.0	-		$V_{DD} = 5.0V$
f_{CLK}	Clock frequency	-	8	-	-	8	-	8	MHz	$V_{DD} = 3.0V$
		-	20	-	-	20	-	20		$V_{DD} = 5.0V$
t_R, t_F	Clock rise and fall times	-	50	-	-	50	-	50	ns	---
t_{ON}	Turn ON time	-	5.0	-	-	5.0	-	5.0	μs	$V_{SIG} = V_{PP} - 10V$, $R_{LOAD} = 10k\Omega$
t_{OFF}	Turn OFF time	-	5.0	-	-	5.0	-	5.0		
dv/dt	Maximum V_{SIG} slew rate	-	20	-	-	20	-	20	V/ns	$V_{PP} = +40V, V_{NN} = -160V$
		-	20	-	-	20	-	20		$V_{PP} = +100V, V_{NN} = -100V$
		-	20	-	-	20	-	20		$V_{PP} = +160V, V_{NN} = -40V$
K_O	OFF isolation	-30	-	-30	-33	-	-30	-	dB	$f = 5.0MHz$, 1.0K Ω /15pF load
		-58	-	-58	-60	-	-58	-		$f = 5.0MHz, 50\Omega$ load
K_{CR}	Switch crosstalk	-60	-	-60	-70	-	-60	-	dB	$f = 5.0MHz, 50\Omega$ load
I_{ID}	Output switch isolation diode current	-	300	-	-	300	-	300	mA	300ns pulse width, 2.0% duty cycle
$C_{SG(OFF)}$	OFF capacitance SW to GND	-	14	-	9.0	14	-	14	pF	$V_{SIG} = 0V, f = 1.0MHz$
$C_{SG(ON)}$	ON capacitance SW to GND	-	17	-	12	17	-	17		
$+V_{SPK}$	Output voltage spike (per switch)	-	-	-	-	150	-	-	mV	$V_{PP} = +40V, V_{NN} = -160V$ $R_{LOAD} = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		
$+V_{SPK}$		-	-	-	-	150	-	-		$V_{PP} = +100V, V_{NN} = -100V$ $R_{LOAD} = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		
$+V_{SPK}$		-	-	-	-	150	-	-		$V_{PP} = +160V, V_{NN} = -40V$ $R_{LOAD} = 50\Omega$
$-V_{SPK}$		-	-	-	-	150	-	-		
QC	Charge injection (per switch)	-	-	-	820	-	-	-	pC	$V_{PP} = +40V, V_{NN} = -160V$
		-	-	-	600	-	-	-		$V_{PP} = +100V, V_{NN} = -100V$
		-	-	-	350	-	-	-		$V_{PP} = +160V, V_{NN} = -40V$

* See Test Circuits on page 5

Test Circuits



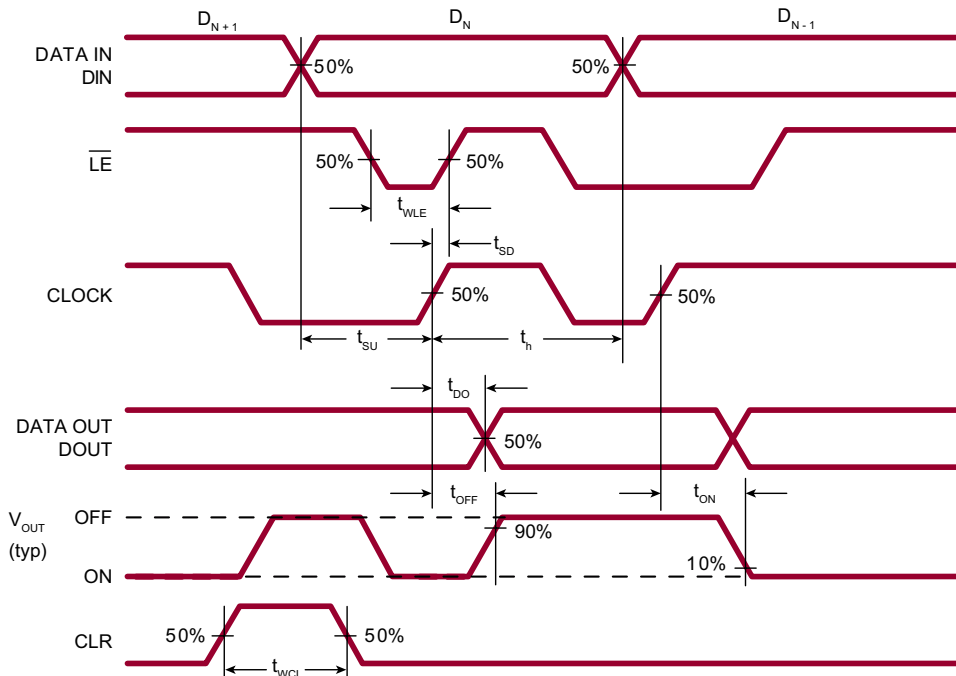
Truth Table

D0	D1	...	D15	D16	...	D23	$\overline{LE}$	CLR	SW0	SW1	...	SW15	SW16	...	SW23
L	-		-	-		-	L	L	OFF	-		-	-		-
H	-		-	-		-	L	L	ON	-		-	-		-
-	L		-	-		-	L	L	-	OFF		-	-		-
-	H		-	-		-	L	L	-	ON		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		L	-		-	L	L	-	-		OFF	-		-
-	-		H	-		-	L	L	-	-		ON	-		-
-	-	...	-	L	...	-	L	L	-	-	...	-	OFF	...	-
-	-		-	H		-	L	L	-	-		-	ON		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		-	L	L	-	-		-	-		-
-	-		-	-		L	L	L	-	-		-	-		OFF
-	-		-	-		H	L	L	-	-		-	-		ON
X	X	X	X	X	X	X	H	L	HOLD PREVIOUS STATE						
X	X	X	X	X	X	X	X	H	ALL SWITCHES OFF						

Notes:

1. The 24 switches operate independently.
2. Serial data is clocked in on the L to H transition of the CLK.
3. All 24 switches go to a state retaining their latched condition at the rising edge of $\overline{LE}$. When $\overline{LE}$ is low the shift registers data flow through the latch.
4. DOUT is high when data in the register 23 is high.
5. Shift registers clocking has no effect on the switch states if $\overline{LE}$ is high.
6. The CLR clear input overrides all other inputs.

Logic Timing Waveforms



Pad Description - 64-Pad LFGA (LA)

Pin	Name
A1	SW22B
A2	VNN
A3	SW21B
A4	SW20B
A5	SW19B
A6	SW18B
A7	SW17B
A8	SW16B
A9	SW15B
A10	SW15A
B1	SW23B
B2	SW23A
B3	SW22A
B4	SW21A
B5	SW20A
B6	SW19A

Pin	Name
B7	SW18A
B8	SW17A
B9	SW16A
B10	SW14B
C1	N/C
C2	VPP
C9	SW14A
C10	SW13B
D1	CLR
D2	NC
D9	VNN
D10	SW13A
E1	$\overline{\text{LE}}$
E2	CLK
E9	SW12B
E10	SW12A

Pin	Name
F1	VDD
F2	GND
F9	SW11B
F10	SW11A
G1	DIN
G2	DOUT
G9	SW10B
G10	VNN
H1	NC
H2	VPP
H9	SW10A
H10	SW9B
J1	SW0A
J2	SW0B
J3	SW1B
J4	SW2B

Pin	Name
J5	SW3B
J6	SW4B
J7	SW5B
J8	SW6B
J9	SW7B
J10	SW9A
K1	SW1A
K2	VNN
K3	SW2A
K4	SW3A
K5	SW4A
K6	SW5A
K7	SW6A
K8	SW7A
K9	SW8A
K10	SW8B

Ball Description - 64-Ball LFGA (LB)

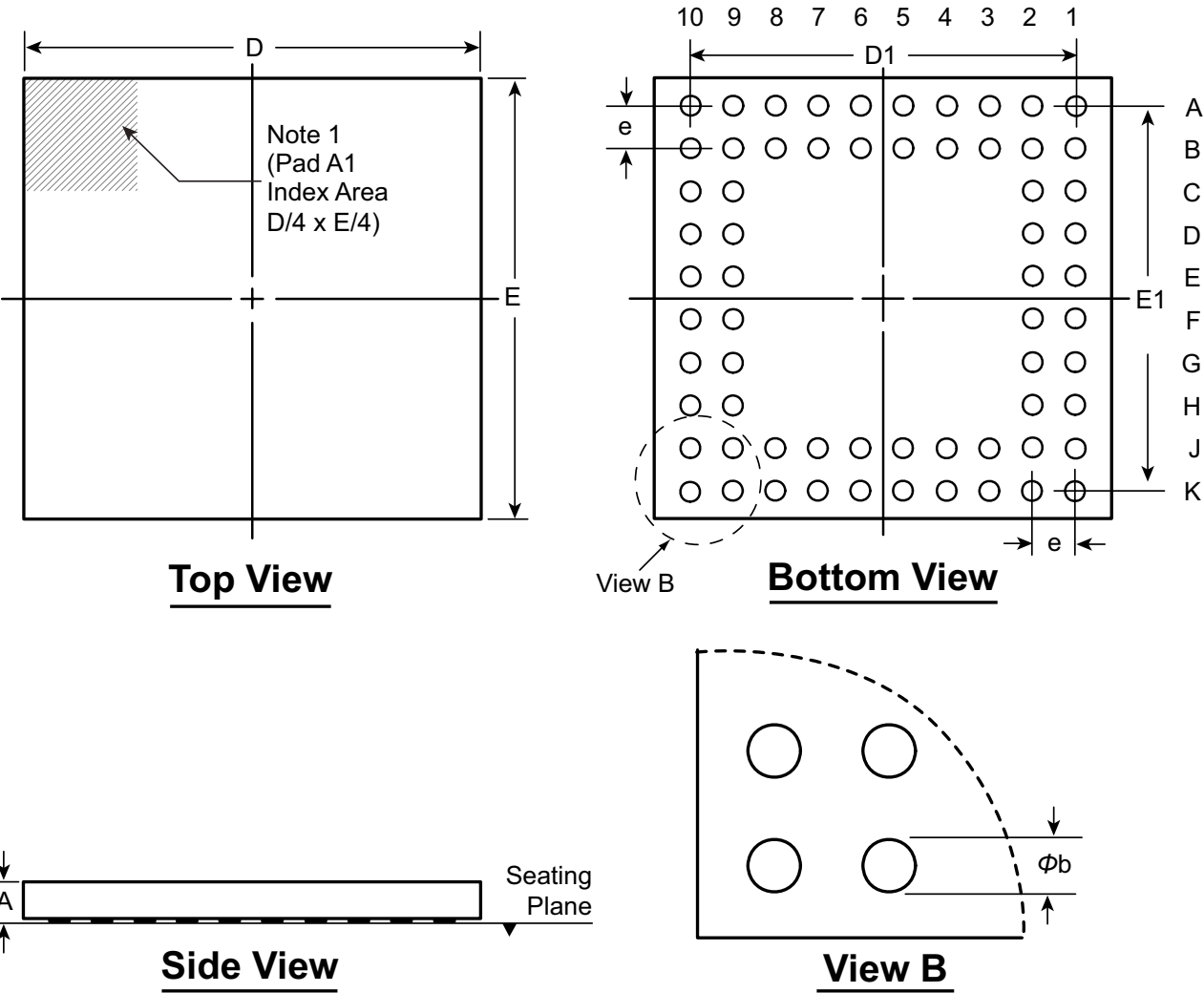
Pin	Name
A1	SW22B
A2	VNN
A3	SW21B
A4	SW20B
A5	SW19B
A6	SW18B
A7	SW17B
A8	SW16B
A9	SW15B
A10	SW15A
B1	SW23B
B2	SW23A
B3	SW22A
B4	SW21A
B5	SW20A
B6	SW19A

Pin	Name
B7	SW18A
B8	SW17A
B9	SW16A
B10	SW14B
C1	N/C
C2	VPP
C9	SW14A
C10	SW13B
D1	CLR
D2	NC
D9	VNN
D10	SW13A
E1	$\overline{\text{LE}}$
E2	CLK
E9	SW12B
E10	SW12A

Pin	Name
F1	VDD
F2	GND
F9	SW11B
F10	SW11A
G1	DIN
G2	DOUT
G9	SW10B
G10	VNN
H1	NC
H2	VPP
H9	SW10A
H10	SW9B
J1	SW0A
J2	SW0B
J3	SW1B
J4	SW2B

Pin	Name
J5	SW3B
J6	SW4B
J7	SW5B
J8	SW6B
J9	SW7B
J10	SW9A
K1	SW1A
K2	VNN
K3	SW2A
K4	SW3A
K5	SW4A
K6	SW5A
K7	SW6A
K8	SW7A
K9	SW8A
K10	SW8B

64-Pad LFGA Package Outline (LA)
7.00x7.00mm body, 0.85mm height (max), 0.65mm pitch

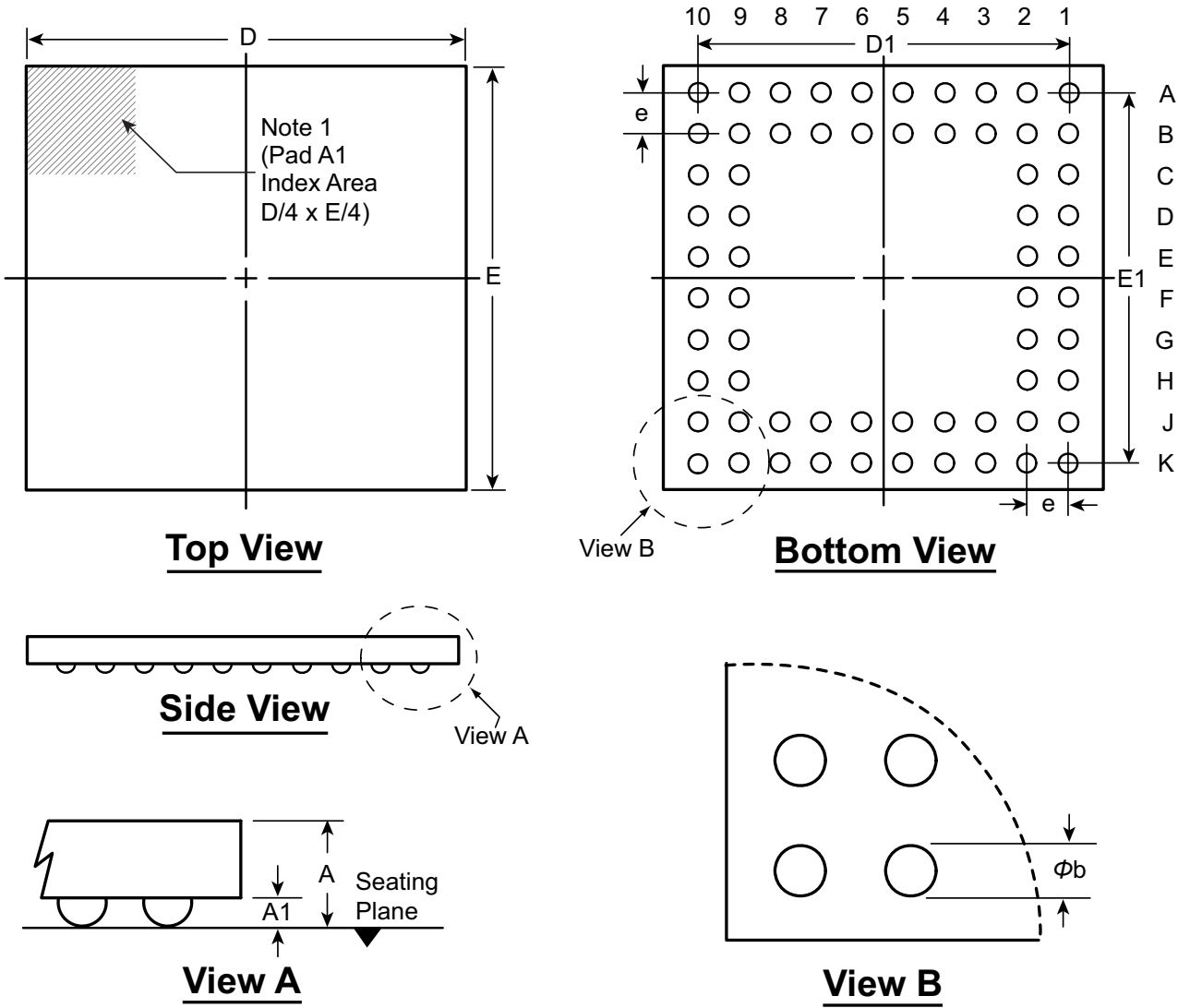


Notes:
1. Pad A1 identifier must be located in the index area indicated. Pad A1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	b	D	D1	E	E1	e
Dimension (mm)	MIN	0.75	0.25	6.925	5.85 BSC	6.925	5.85 BSC	0.65 BSC
	NOM	0.80	0.30	7.000		7.000		
	MAX	0.85	0.35	7.075		7.075		

Drawings not to scale.
Supertex Doc. #: DSPD-64LFGALA, Version A021511.

64-Ball LFGA Package Outline (LB)
7.00x7.00mm body, 1.00mm height (max), 0.65mm pitch



Notes:
1. Ball A1 identifier must be located in the index area indicated. Ball A1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	A1	b	D	D1	E	E1	e
Dimension (mm)	MIN	0.90	0.10	0.25	6.925	5.85 BSC	6.925	5.85 BSC	0.65 BSC
	NOM	0.95	0.15	0.30	7.000		7.000		
	MAX	1.00	0.20	0.35	7.075		7.075		

Drawings not to scale.
Supertex Doc. #: DSPD-64LFGALB, Version A021511.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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Мы предлагаем:

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Доставку товара в любую точку России и стран СНГ.
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- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

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Конструкторский отдел помогает осуществить:

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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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